

T495, Tantalum, MnO2 Tantalum, 33 uF, 10%, 25 VDC, SMD, MnO2, Molded, Low ESR, 300 mOhms, 7343, Height Max = 3.1mm



Dimensions	
Footprint	7343
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
H	2.8mm +/-0.3mm
T	0.13mm REF
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
A	3.6mm MIN
B	0.5mm +/-0.15mm
E	3.5mm REF
G	3.5mm REF
P	0.9mm REF
R	1mm REF
X	0.1mm +/-0.1mm

Packaging Specifications	
Packaging:	T&R, 178mm
Packaging Quantity:	500

General Information	
Series:	T495
Dielectric:	MnO2 Tantalum
Style:	SMD Chip
Description:	SMD, MnO2, Molded, Low ESR
Features:	Low ESR
RoHS:	Yes
Termination:	Tin
AEC-Q200:	No
Component Weight:	446.84 mg
Shelf Life:	156 Weeks
MSL:	1

Specifications	
Capacitance:	33 uF
Capacitance Tolerance:	10%
Voltage DC:	25 VDC (85C), 16.75 VDC (125C)
Temperature Range:	-55/+125°C
Rated Temperature:	85°C
Dissipation Factor:	6% 120Hz 25C
Failure Rate:	N/A
Resistance:	300 mOhms (100kHz 25C)
Ripple Current:	707 mA (rms, 100kHz 25C), 636.3 mA (rms, 85C), 282.8 mA (rms, 125C)
Leakage Current:	8.3 uA (5min 25°C)

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.